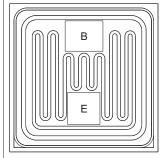


# **CP310-MPSA42** NPN - High Voltage Transistor Die

The CP310-MPSA42 is a silicon NPN transistor designed for high voltage applications.



BACKSIDE COLLECTOR

	MECHANICAE OF ECH ICAN	0110.
	Die Size	26 x 26 MILS
	Die Thickness	9.0 MILS
	Base Bonding Pad Size	6.1 x 4.9 MILS
	Emitter Bonding Pad Size	5.2 x 5.2 MILS
	Top Side Metalization	AI – 30,000Å
	Back Side Metalization	Au – 9,000Å
	Scribe Alley Width	2.2 MILS
	Wafer Diameter	5 INCHES
	Gross Die Per Wafer	25,214
2		

## MECHANICAL SPECIFICATIONS:

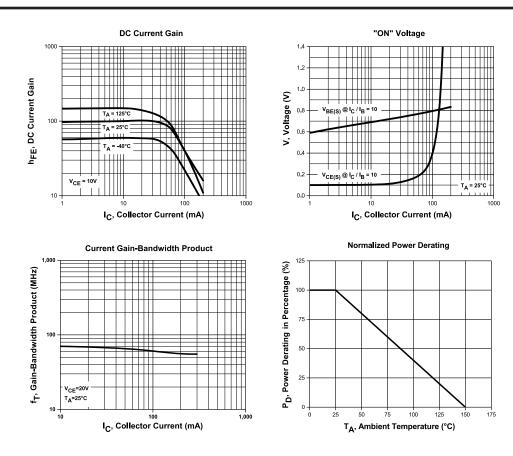
MAXIMUM F	RATINGS: (T <sub>A</sub> =25°C)	SYMBOL		UNITS
Collector-Bas	se Voltage	V <sub>CBO</sub>	300	V
Collector-Em	itter Voltage	VCEO	300	V
Emitter-Base	Voltage	V <sub>EBO</sub>	6.0	V
Continuous (	Collector Current	۱ <sub>C</sub>	500	mA
Operating an	d Storage Junction Temperature	T <sub>J,</sub> T <sub>stg</sub>	-65 to +150	°C
ELECTRICA SYMBOL I <sub>CBO</sub>	L CHARACTERISTICS: $(T_A=25^{\circ}C)$ TEST CONDITIONS $V_{CB}=200V$	MIN	<b>MAX</b> 100	UNITS nA
I <sub>EBO</sub>	V <sub>EB</sub> =6.0V		100	nA
BVCBO	Ι <sub>C</sub> =100μΑ	300		V
BVCEO	I <sub>C</sub> =1.0mA	300		V
BVEBO	Ι <sub>Ε</sub> =100μΑ	6.0		V
V <sub>CE</sub> (SAT)	I <sub>C</sub> =20mA, I <sub>B</sub> =2.0mA		0.5	V
V <sub>BE(SAT)</sub>	I <sub>C</sub> =20mA, I <sub>B</sub> =2.0mA		0.9	V
h <sub>FE</sub>	V <sub>CE</sub> =10V, I <sub>C</sub> =1.0mA	25		
h <sub>FE</sub>	V <sub>CE</sub> =10V, I <sub>C</sub> =10mA	40		
h <sub>FE</sub>	V <sub>CE</sub> =10V, I <sub>C</sub> =30mA	40		
fT	$V_{CE}$ =20V, I <sub>C</sub> =10mA, f=100MHz	50		MHz

R1 (9-May 2016)

# **CP310-MPSA42** Typical Electrical Characteristics



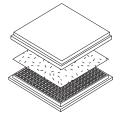
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## BARE DIE PACKING OPTIONS



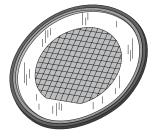


## BARE DIE IN TRAY (WAFFLE) PACK

- CT: Singulated die in tray (waffle) pack. (example: CP211-PART NUMBER-CT)
- CM: Singulated die in tray (waffle) pack 100% visually inspected as per MIL-STD-750, (method 2072 transistors, method 2073 diodes). (example: CP211-<u>PART NUMBER</u>-CM)

## **UNSAWN WAFER**

WN: Full wafer, unsawn, 100% tested with reject die inked. (example: CP211-PART NUMBER-WN)



## SAWN WAFER ON PLASTIC RING

WR: Full wafer, sawn and mounted on plastic ring, 100% tested with reject die inked. (example: CP211-PART NUMBER-WR)

Please note: Sawn Wafer on Metal Frame (WS) is possible as a special order. Please contact your Central Sales Representative at 631-435-1110.



Visit the Central website for a complete listing of specifications: www.centralsemi.com/bdspecs

www.centralsemi.com

## **OUTSTANDING SUPPORT AND SUPERIOR SERVICES**

#### **PRODUCT SUPPORT**

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- · Consolidated shipping options

#### **DESIGNER SUPPORT/SERVICES**

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities

Special wafer diffusions

· Custom product packing

- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits

Custom bar coding for shipments

Custom product and package development

### **REQUESTING PRODUCT PLATING**

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

#### CONTACT US

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